

Abdullah Muhammad - CV

Hasso Plattner Institute PhD Candidate
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Education

<i>Hasso Plattner Institute, Germany</i> Ph.D. in Human Computer Interaction Advisor: Patrick Baudisch	2019-now
<i>Kyung Hee University, South Korea</i> M.S. in Computer Engineering Advisor: Seokhee Jeon	2016-2018
<i>National University of Science and Technology, Pakistan</i> B.E. in Electrical Engineering	2008-2012

Full papers at CHI/UIST/SCF

- [9] **Muhammad Abdullah**, Laurenz Seidel, Ben Wernicke, Mehdi Gouasmi, Anton Hackl, Thomas Kern, Conrad Lempert, Clara Lempert, David Bizer, Wieland Storch, Chiao Fang, and Patrick Baudisch. PopCore: Personal Fabrication of 3D Foamcore Models for Professional High-Quality Applications in Design and Architecture. **SCF24**
- [8] Lukas Rambold, Robert Kovacs, Conrad Lempert, **Muhammad Abdullah**, Helena Lendowski, Lukas Fritzsche, Martin Taraz, and Patrick Baudisch. AirTied: Automatic Personal Fabrication of Truss Structures. **UIST23**
- [7] Shohei Katakura, Martin Taraz, **Muhammad Abdullah**, Paul Methfessel, Lukas Rambold, Robert Kovacs, and Patrick Baudisch. Kerfmeter: Automatic Kerf Calibration for Laser Cutting. **CHI23**
- [6] **Muhammad Abdullah**, Romeo Sommerfeld, Bjarne Sievers, Leonard Geier, Jonas Noack, Marcus Ding, Christoph Thieme, Laurenz Seidel, Lukas Fritzsche, Erik Langenhan, Oliver Adameck, Moritz Dzingel, Thomas Kern, Martin Taraz, Conrad Lempert, Shohei Katakura, Hany Mohsen Elhassany, Thijs Roumen, and Patrick Baudisch. HingeCore: Laser-Cut Foamcore for Fast Assembly. **UIST22**
- [5] **Muhammad Abdullah**, Romeo Sommerfeld, Laurenz Seidel, Jonas Noack, Ran Zhang, Thijs Roumen, and Patrick Baudisch. Roadkill: Nesting Laser-Cut Objects for Fast Assembly. **UIST21 Best Paper Honorable Mention (top 5%)**
- [4] Keunwoo Park, Conrad Lempert, **Muhammad Abdullah**, Shohei Katakura, Jotaro Shigeyama, Thijs Roumen, and Patrick Baudisch. FoolProofJoint: Reducing Assembly Errors of Laser Cut 3D Models by Means of Custom Joint Patterns. **CHI22**

[3] **Muhammad Abdullah**, Martin Taraz, Yannis Kommana, Shohei Katakura, Robert Kovacs, Jotaro Shigeyama, Thijs Roumen, and Patrick Baudisch. FastForce: Real-Time Reinforcement of Laser-Cut Structures. **CHI21**

[2] Thijs Roumen, Yannis Kommana, Ingo Apel, Conrad Lempert, Markus Brand, Erik Brendel, Laurenz Seidel, Lukas Rambold, Carl Goedecken, Pascal Crenzin, Ben Hurdelhey, **Muhammad Abdullah**, and Patrick Baudisch. Assembler³: 3D Reconstruction of Laser-Cut Models. **CHI21**

[1] Thijs Roumen, Ingo Apel, Jotaro Shigeyama, **Muhammad Abdullah**, and Patrick Baudisch. Kerf-canceling mechanisms: making laser-cut mechanisms operate across different laser cutters. **UIST20**

Full papers at other conferences and in journals

[5] Waseem Hassan, Ahsan Raza, **Muhammad Abdullah**, Mohammad Shadman Hashem, and Seokhee Jeon. HapWheel: Bringing In-Car Controls to Driver's Fingertips by Embedding Ubiquitous Haptic Displays into a Steering Wheel. **IEEE Transactions on Intelligent Transportation Systems, 2022**

[4] Joolekha Bibi Joolee, Ahsan Raza, **Muhammad Abdullah**, and Seokhee Jeon. Tracking of Flexible Brush Tip on Real Canvas: Silhouette-Based and Deep Ensemble Network-Based Approaches. **IEEE Access, 2020**

[3] **Muhammad Abdullah**, Waseem Hassan, Ahsan Raza, and Seokhee Jeon. Haptic Logos: Insight into the feasibility of digital haptic branding. **Eurohaptics 2018 Best Paper Honorable Mention (top 8%)**

[2] **Muhammad Abdullah**, Minji Kim, Waseem Hassan, Yoshihiro Kuroda, and Seokhee Jeon. HapticDrone: An encountered-type kinesthetic haptic interface with controllable force feedback: Example of stiffness and weight rendering. **IEEE Haptics Symposium 2018**

[1] Waseem Hassan, Arsen Abdulali, **Muhammad Abdullah**, Sang Chul Ahn, and Seokhee Jeon. Towards universal haptic library: Library-based haptic texture assignment using image texture and perceptual space. **IEEE Transactions on Haptics, 2017**

Invited Talks

[4] Stanford University, Hosted by James Landay	2025
[3] Boston University, Hosted by Emily Whiting	2025
[2] SIGGRAPH, The Future of Advanced User Interfaces	2023
[1] SAP Symposium	2022

Professional Activities

Member of program committees

UIST 2024 (full papers)
DIS 2024 (full papers)
UIST 2024 (posters)
UIST 2023 (posters)
TEI 2022 (WIP)

Member of organizing committees

UIST 2025 Posters chair
UIST 2024 Best Paper Committee
UIST 2024 Ask Me Anything chair
DIS 2024 Best Paper Committee

Reviewer

CHI (2021-2025)
UIST (2022-2024)
SCF (2023-2024)
DIS (2024-2025)
TVCG (2021)
other ACM and IEEE venues

Special recognitions for reviews

3x UIST
2x CHI
1x DIS

Teaching

Created Courses, primary lecturer

Algorithmic Folding, master course at HPI **Winter 2021-2025**

Teaching Assistant

HCI Future Interactive technology, master course at HPI **Summer 2020-2023**
Advanced HCI, master-PhD course at Kyung Hee University **Winter 2018**
Expert Systems, master-PhD course at Kyung Hee University **Summer 2018**

Funding

Rethinking product design of 3d printed objects with recycled materials (100k) **2024-ongoing**
Personalizing product design with minimal material waste (100k) **2023-2024**

Mentoring

Research Intern (4 months full time)

[2] Charles Cai **2024**
[1] Keunwoo Park (paper at CHI22) **2021**

Master Thesis (6 months full time)

[3] Lukas Fritzsche **2023**
[2] Lukas Budach **2022**
[1] Laurenz Seidel **2022**

Master Project Students (6 month—3 days per week)

[16] Julian Arnold	2025	[8] Jonas Embach	2024
[15] Enriketa Krriku	2025	[7] Maximilian Goetz	2024
[14] Phillip Keese	2025	[6] Bjarne Sievers	2021
[13] Johannes Poetzsch	2025	[5] Marcus Ding	2021
[12] Lino Hellige	2025	[4] Erik Langenhan	2021
[11] Chiao Fang	2024	[3] Jonas Noack	2020
[10] Julian Egbert	2024	[2] Lukas Fritzsche	2020
[9] Daphna Beljavskij	2024	[1] Oliver Adameck	2020

Research Project Students (2 days per week for a semester)

[14] Tobias Goergens	2025	[7] Anton Hackl	2022
[13] Enriketa Krriku	2024/25	[6] Ben Wernicke	2021/23
[12] Lino Hellige	2024	[5] Romeo Sommerfeld	2020/21
[11] Margarete Dippel	2024	[4] Leonard Geier	2021
[10] Ella Rosner	2024	[3] Moritz Dzingel	2021
[9] Daphna Beljavskij	2023	[2] Laurenz Seidel	2020
[8] Mehdi Gouasmi	2022	[1] Martin Taraz	2019

Awards and Honors

Best paper honorable mention, ACM UIST 2021

Best paper honorable mention, EuroHaptics 2018

President's scholarship, Kyung Hee University 2016-2018

Research scholarship, Haptics and Virtual Reality Lab 2016-2018